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Micro-stereolithography of polymeric and ceramic microstructures

X. Zhang *, X.N. Jiang, C. Sun

Department of Industrial and Manufacturing Engineering, The Pennsylvania State University, University Park, PA 16802, USA

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Abstract

Micro-stereolithography (μ SL) is a novel micro-manufacturing process which builds the truly 3D microstructures by solidifying the liquid monomer in a layer by layer fashion. In this work, an advanced μ SL apparatus is designed and developed which includes an Ar⁺ laser, the beam delivery system, computer-controlled precision x-y-z stages and CAD design tool, and in situ process monitoring systems. The 1.2 μ m resolution of μ SL fabrication has been achieved with this apparatus. The microtubes with high aspect ratio of 16 and real 3D microchannels and microcones are fabricated on silicon substrate. For the first time, μ SL of ceramic microgears has been successfully demonstrated. © 1999 Elsevier Science S.A. All rights reserved.

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1. Introduction

As an emerging technology, Micro Electro-Mechanical Systems (MEMS) have drawn worldwide research attention in the last decade. MEMS devices have been found in many sensing applications such as airbag sensors, as well as chemical and biological sensors. In order to develop the intelligent 'micro-system' which is capable of both sensing and actuating, microactuators is the key to making MEMS a fully active device [1]. The microactuators with high output power can be achieved by using real 3D high aspect ratio microstructures [2], adopting novel actuation mechanisms [1,3], and incorporating a broader spectrum of materials into MEMS such as smart ceramics and alloys beyond conventional materials used in IC fabrication [4–6].

Current IC-based micromachining processes used to fabricate MEMS devices have certain limitations in achieving the above goals. First, most of the IC-based micromachining processes cannot be used to fabricate complex 3D micro parts with high aspect ratios. Second, only a few semiconductors and other materials can be processed by the current IC-based micromachining for MEMS. Many other important engineering materials, such as smart ceramics, functional polymer, and metal alloys, cannot be directly incorporated into MEMS through the conventional IC-based micromachining processes. As an alternative, X-ray LIGA (German Lithography, electroforming and molding) process was developed to fabricate microstructures with high aspect ratio [7,8]. However, the X-ray LIGA process has not found a large number of industrial applications due to its limited industrial accessibility and high operational cost. In addition, complex 3D structures cannot be easily achieved by LIGA process. Recently, a new three-dimensional microfabrication technique is developed based on two-photon absorption with micron resolution [9,10]. This approach provides a new way to directly write a 3D microstructure in free form. In the two-photon microfabrication, however, a short-pulsed laser with a high peak-power is required in order to achieve polymerization since the quantum efficiency is quite low. In addition, the two-photon polymerization is limited to the 3D microfabrication from transparent resin, since the laser beam cannot be easily focused inside of the ceramic and metal suspensions. A novel microfabrication process, the µSL was introduced to fabricate high aspect ratio and complex 3D-microstructure [11]. Sophisticated 3D parts can be made by scanning an UV beam on the liquid monomer resin, curing the resin into solid polymer layer by layer, and stacking together all layers with various contours. In contrast to conventional subtractive micromachining, the μ SL is an additive process, which enables one to fabricate high aspect ratio microstructures with novel smart materials. The µSL process is, in principle, compatible with silicon processes and batch fabrication is also feasible [12]. The µSL fabrications of micropolymeric parts and subse-

^{*} Corresponding author. Tel.: +1-814-863-3216; Fax: +1-814-863-4745; E-mail: xxz10@psu.edu

quently electro-plating of micrometallic parts have been explored [13–15]. Functional polymer micro parts possess unique characteristics of high flexibility and low density, as well as reasonable electric conductivity in conducting polymers and piezoelectricity in piezo-polymers. Microceramic structures, however, have not been realized yet by μ SL, though they are the keys to high temperature and corrosion resistant MEMS devices. Fabrication of 3D complex shape ceramic turbines is critical for microengine application. The finest UV beam spot sizes reported were about 5 μ m, which is larger as compared with the resolution of current IC-based micromachining processes. The control of fine line width in μ SL is essential to improve the accuracy of micro parts. In this paper, a novel µSL system is designed and developed. The polymer microfabrication on silicon substrate via µSL is investigated to achieve fine line width control. The feasibility of ceramic microfabrications via µSL is explored.

2. μSL

 μ SL is derived from conventional stereolithography, which is used to fabricate polymer molds in rapid prototyping processes [16]. The basic principle of stereolithography is schematically shown in Fig. 1. A 3D solid model designed with CAD software is sliced into a series of 2D layers with uniform thickness. The NC code generated from each sliced 2D file is then executed to control a motorized x-y stage carrying a vat of UV curable solution. The focused scanning UV beam is absorbed by an UV curable solution consisting of monomer and photoinitiators, leading to the polymerization, i.e., conversion of the liquid monomer to the solid polymer. As a result, a polymer layer is formed according to each sliced 2D file. After one layer is solidified, the elevator moves downward and a new layer of liquid resin can be solidified as the next layer. With the synchronized x-y scanning and the Z-axis motion, the complicated 3D micro part is built in a layer by layer fashion. The µSL shares the same principle with its macroscale counterpart, but in different dimensions. In



Fig. 1. The principle of stereolithography.

 μ SL, an UV laser beam is focused to $1-2 \mu$ m to solidify a thin layer of $1-10 \mu$ m in thickness. Submicron resolution of the x-y-z translation stages and the fine UV beam spot enable precise fabrication of real 3D complex microstructures.

In polymer μ SL, the solidified line width and the depth are two important parameters. Upon laser exposure, the photopolymer obeys the Beer–Lambert law of absorption. Earlier macro-scale experiments suggested that the photopolymer has a threshold exposure and curing depth, can be expressed in the following working curve as [16]:

$$C_{\rm d} = D_{\rm p} \ln(E/E_{\rm c}) \tag{1}$$

where C_d is the curing depth, D_p is the penetration depth of the resin defined as $D_p = 1/(2.3\varepsilon[I])$ (ε is the molar extinction coefficient of the initiator, [I] is the initiator concentration), and E and E_c are the laser exposure on the resin surface and critical exposure of the resin at the laser wavelength, respectively. Critical exposure is the laser energy below which the polymerization does not occur. The polymerized line width is described as:

$$L_{\rm w} = B_{\rm V} C_{\rm d} / (2D_{\rm p}) \tag{2}$$

where L_w is the cured line width, and *B* is the laser spot diameter. The micropolymer structures with different line widths and layer depths can be fabricated by adjusting the laser beam spot size and the exposure energy. For a given UV laser wavelength, the laser exposure is a function of scan speed, laser power and spot size [16].

In Ceramic μ SL, an UV curable ceramic suspension is prepared with monomers, photoinitiators and ceramic powders. Upon UV polymerization, the ceramic particles are bonded by the polymer and the ceramic green body is thus formed. The curing depth is found from previous macroscale experiment [17,18] as:

$$C_{\rm cd} \approx \left(\frac{d}{Q}\right) \left(\frac{1}{\Phi}\right) \ln(E/E_{\rm c})$$
$$Q = \left(\frac{\Delta n}{n_0}\right)^2 \left(\frac{d}{\lambda}\right)^2 \tag{3}$$

where *d* is the mean particle size of the ceramic powder, Φ is the volume fraction of ceramics in the suspension, n_0 is the refractive index of the monomer solution, Δn is the refractive index difference between the ceramics and the monomer solution, and λ is the UV wavelength. Compared with the polymer stereolithography, additional factors influence the line width and the curing depth in ceramic stereolithography, such as the particle size and the refractive indexes of the ceramic powder and the solution. Therefore, μ SL of microceramic parts is much more complicated than the μ SL of pure polymer. It should be noted that the above curing depth and line width relations (Eqs. (1)–(3)) were obtained from macroscopic stereolithography experiments. Their validity in μ SL is currently under experimental investigation.

3. Experiments

Experiments were designed to (1) test the constructed μ SL apparatus; (2) investigate the μ SL of polymeric parts with 3D high aspect ratio; and (3) explore the μ SL of ceramic parts for the first time.

An advanced µSL apparatus has been designed and constructed in this work. The µSL apparatus consists of four major parts: an Ar⁺ laser, a beam delivery system, computer-controlled precision x-y-z stages and a CAD design tool, and an in situ process monitoring systems. The schematic diagram of the developed µSL apparatus is shown in Fig. 2. The optical setup includes an Ar⁺ laser and the beam delivery and focusing optics. As an UV source, the Ar⁺ laser was implemented here instead of the UV lamp used in previous work [13,14], in order to obtain a smaller spot size and more stable beam intensity. The scanning control system consists of precision x-y-z stages with 0.5 μ m resolution, an elevator attached to the Z-axis, and an x-y-z stage controller. A CAD tool provides 3D model design of the microstructures, slicing and the NC code generation. The monitoring system includes a CCD camera, light source and a monitor, which enables one to inspect microfabrication processes in situ. The smallest UV beam spot size achieved was $1-2 \mu m$. The laser wavelength used in this work is 364 nm although two other UV wavelengths, 337 nm and 351 nm, are also available from this Ar⁺ laser.

Three UV curable solutions were used in this work: HDDA (the 1,6-hexanediol diacrylate) based resin, aqueous ceramic suspension and non-aqueous ceramic suspension. For polymer microfabrication, the HDDA based UV



Fig. 2. The μ SL apparatus developed at Penn State including an Ar⁺ laser, a beam delivery system, computer-controlled precision x–y–z stages and a CAD design tool, and an in situ process monitoring system.



Curing depth

Fig. 3. Micro windowpane structure designed for measurement of the curing depth in μ SL of HDDA: (a) top view; (b) side view.

curable resin was prepared, which includes the HDDA monomer and the photoinitiator (benzoin ethyle ether). The photoinitiator was mixed with HDDA for a couple of minutes and fully dispersed after a few hours. The fresh HDDA solution with the photoinitiator concentration of 4 wt.% is transparent, but turns light yellow after exposure to air for more than 24 h. Aqueous ceramic suspension and non-aqueous ceramic suspension were prepared for the ceramic microfabrication [18-20]. The non-aqueous UV curable ceramic suspension contains the HDDA monomer, the photoinitiator, the fine alumina powder (RC-UFX DBM alumina powders), the solvent (DBE, a mixture of dibasic esters) and the dispersant (Triton X-100). The aqueous UV curable ceramic suspension, on the other hand, was prepared with DI water, the monomer (acrylamide and methylenebisacrylamide), the fine alumina powder, the dispersant (Darvan C) and the photoinitiator (Irgacure 2959). The premix solution containing monomer, solvent, photoinitiator and dispersant was prepared first. Subsequently, ceramic powders were added into the premix solution and ball milled for several hours. In this work, the solid loading of the fine alumina powders was about 33% (volume fraction) and the mean particle size of the alumina powders was about 0.2 µm.

The polymerization of the HDDA based resin was characterized under various laser exposures. The micro windowpane experiment was performed for curing depth measurement, as shown in Fig. 3 [16]. Seven parallel support beams work as a bridge between two support posts and five fabricated micropanes are then suspended by the support beams. The support post is 300 μ m long, 100 μ m wide and 1 mm high. The support beams are 1.76 mm long. Five micropanes designed with the same surface sizes of 400 × 150 μ m were fabricated with different laser exposures, which results in various curing depths. The single line polymerization was also investigated for testing the resolution of the μ SL apparatus and the line width

control. In μ SL of polymers, both single and multiple layer microstructures were fabricated, including microgears, microchannels, microtubes and microcones with the sizes varying from 100 μ m to 1 mm on silicon substrate. The laser power used for μ SL of polymer and ceramics was about 5–15 mW. In μ SL of ceramics, green bodies of single layer microceramic gears of 400 μ m and 1mm were fabricated. The green bodies subsequently went through burn out at temperature of 550–600°C for 2 h. Microceramic gears were finally sintered in the furnace at 1400°C for 3 h in the air environment.

4. Results and discussions

4.1. HDDA polymerization

The micro windowpane structures were fabricated with different laser exposures. The dependence of curing depth on the logarithm of laser exposure is found linear which suggests that microscale polymerization follows the working curve described by Eq. (1) (Fig. 4a). The critical



Fig. 4. HDDA UV polymerization characterization: (a) the curing depth dependence on the laser exposure measured from microwindowpane test; (b) the line width dependence on the laser exposure measured from single line scan experiment with confined layer thickness of 10 μ m.



Fig. 5. μ SL of single layer polymer (HDDA): (a) 400 μ m microgear with the filling line width of 5 μ m and the thickness of 30 μ m; (b) 100 μ m microgear with the thickness of 15 μ m; (c) 2 μ m line width achieved in 400 μ m microgear fabrication.

exposure E_c and the penetration depth D_p of HDDA used (the concentration of photoinitiator is 4 wt.%) are determined to be 111 mJ/cm² and 242 μ m, respectively, through the least square fitting method. For a fixed layer thickness, the polymerized line width increases with laser exposure (Fig. 4b). With a layer thickness of 10 μ m, a 1.4 μ m thin line was achieved at a laser power of 2.2 μ W. The finest line obtained in this work is 1.2 μ m wide using the developed apparatus.

4.2. μ SL of polymers

The single layer polymeric microgears with diameters of 100 and 400 μ m were successfully fabricated on silicon substrate by μ SL, as shown in Fig. 5. The teeth width is 12.5 μ m in 100 μ m gears and 50 μ m in 400 μ m gears. It



Fig. 6. High aspect ratio micropolymer parts fabricated by multiple layer μ SL of HDDA with the layer thickness of 20 μ m: (a) microchannels with 100 μ m in width and 300 μ m in height; (b) a microtube with inner diameter of 50 μ m and height of 800 μ m.



Fig. 7. μ SL of 3D complex microstructure: a microcone with bottom diameter of 500 μ m and height of 250 μ m.

is observed that the gear shape is well defined with a uniform thickness (Fig. 5a). After fabrication and postcleaning, an average shrinkage in the microgears is found to be less than 5%. The polymerized line width is found to be about 5 μ m as shown in an enlarged section of the fabricated 400 µm gear (Fig. 5a). The space between the two adjacent beam scans is about 8 µm, which is wider than the polymerized 5 μ m line, resulting in a 3 μ m blank space between the two adjacent solid lines. Good definition is also obtained in the 100 µm microgear fabricated by µSL (Fig. 5b). In both 400 and 100 µm microgears, an overcast layer on the external profiles of the micro parts is observed. The overcast may result from the longer laser exposure on the monomer due to the acceleration and the de-acceleration of the x-y stage at the beginning and the end of each scan pass. As a test of the resolution of the developed apparatus, a microgear with filling lines as fine as 2 µm was fabricated on silicon substrate (Fig. 5c). It is found that controlling the appropriate laser exposure and the beam diameter is the key to achieving high definition in μ SL. Factors that influence the laser exposure include the scanning speed, the scanning space between the two adjacent lines, the laser power and the thickness of liquid monomer layer.

The high aspect ratio microstructures were fabricated with multiple layers by the μ SL. Microchannels and a microtube fabricated on silicon substrates are shown in Fig. 6a and b, respectively. The width of the microchannel is 100 μ m and the height of the channel is about 300 μ m. The microtube has an inner diameter of 50 μ m and the total length of 800 μ m, which suggests that the aspect ratio of microtube is about 16. Microstructures with even higher aspect ratios can be achieved by μ SL due to its layer by layer construction, in contrast to the current IC-based micromachining processes for MEMS. As a 3D microfabrication technique, μ SL can form microstructures with complex shapes. A polymer micro convex cone was



Fig. 8. μ SL of ceramics: 1 mm microgear with thickness of 20 μ m fabricated from *aqueous* alumina suspension with the solid loading of 33%; (a) Green body after μ SL; (b) after 3 h sintering at 1400°C.

fabricated with 25 layers, as shown in Fig. 7, which was constructed. The bottom diameter of the cone is 500 μ m and the layer thickness is 10 μ m. The demonstrated truly 3D microfabrication capability in the μ SL offers great opportunities in design and applications of highly functional microactuators. The single layer fabrication of the microgears (Fig. 5) took less than 1 min. The multiple layer microtube (Fig. 6b) took about 30 min. The rapid fabrication is possible by adjusting the scanning speed and the laser exposure.

4.3. Ceramic microfabrication

For the first time, microceramic structures were successfully fabricated in this work by μ SL. The alumina microgears with diameters of 400 and 1000 μ m were fabricated from both the aqueous and non-aqueous alumina suspensions with the solid loading of 33% (volume fraction). After fabrication of green body microgears from the aqueous alumina suspension, the burn out and sintering

experiments were conducted. The shapes of the alumina microgear before and after sintering are compared in Fig. 8a and b, respectively. The diameter of the alumina microgear decreases from 1032 µm in the green body to 866 µm after sintering. The density of the sintered gear is estimated about 2.2 g/cm³, which is 56% of the full density (3.9 g/cm^3) . This is due to the low solid loading of the suspension and the relatively low sintering temperature (typical sintering temperature of alumina is around 1550-1600°C). Although the linear shrinkage from the sintering is about 16%, the overall shape of the microgear undergoes little change due to the sintering. Higher solid loading in ceramic suspension is expected to result in less shrinkage during sintering. However, the higher solid loading likely leads to higher viscosity of the ceramic suspension which makes the layer thickness control more difficult in μ SL [17]. The green bodies of the single layer alumina microgears shown in Fig. 9 were fabricated from the non-aqueous alumina suspension. Compared with their polymer counterparts, the fabricated ceramic gears have a relatively poorer definition. This is mainly due to the UV light scattering by ceramic particles during the laser poly-



Fig. 9. μ SL of ceramic microgears from *non-aqueous* alumina suspension with the solid loading of 33%: (a) 400 μ m microgear; (b) 1 mm microgear.

merization of the ceramic suspension. The measured outer diameter of the gear is 1027 µm, which is larger than the designed value of 1000 μ m. The thickness of both 1000 and 400 μ m single layer gears is about 20 μ m. It is also found that a thinner layer of the ceramic suspension results in a better definition since the scattering effect is reduced with decrease of the layer thickness. In order to fabricate the finer ceramic microstructures by µSL, the process optimization of line width and depth is necessary, which includes reduction of the focused beam spot size and the scattering effect from the ceramic suspension [21]. The ceramic suspension with lower viscosity is desirable in µSL because it makes the flow of a thin liquid monomer layer and therefore the layer thickness control easier. At the same solid loading, the viscosity of the aqueous suspension is found to be lower than that of the non-aqueous suspension. However, severe cracks and distortions may occur in the microceramic parts fabricated from aqueous ceramic suspension during post-cleaning and sintering process. The soft cleaning solvent in post-cleaning and the slow temperature ramp-up during the burning and sintering processes are found to be effective to reduce the distortion of microceramic parts fabricated from aqueous suspension. Similar to µSL of ceramic microgears demonstrated in this work, many other important engineering materials such as SMA alloy and metal powders can also be incorporated into μ SL. The μ SL provides a unique solution to fabricate micro parts with truly 3D complex shapes, high aspect ratios and a wide variety of functional materials.

5. Conclusions

An advanced μ SL apparatus was developed, which consists of an Ar⁺ laser, a beam delivery system, computer controlled precise x-y-z stages and a CAD design tool, and an in situ process monitoring system. This apparatus is capable of fabricating a line width as fine as 1.2 μ m. The successful μ SL of microgears, microtubes and micro convex cone structures demonstrated its unique capability of fabrication of micro parts with truly 3D complex shapes, high aspect ratios and a wide variety of functional materials. For the first time, the ceramic microfabrication by μ SL was successfully demonstrated. The 400 and 1000 μ m microceramic gears were fabricated with reasonable definition. The densified microceramic parts were obtained after the burning and sintering processes.

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Xiang Zhang graduated with PhD in mechanical engineering from University of California, Berkeley in 1996 and MS/BS in Physics from Nanjing University. He joined Pennsylvania State University in 1996 as an assistant professor and directs Penn State's Micro-manufacturing Laboratory (μ ML). His past research experiences include: micro thermal wave sensor design and fabrication, ferroelectric liquid crystal phase transition, high- T_c superconductivity, laser processing of semiconductor materials. His current research interests are: 3D micromachining, μ SL for MEMS and microsensors and actuators.

Xiaoning Jiang received his PhD from Tsinghua University, Beijing, China in 1996. His PhD thesis is about microfluid flow and the fabrication of micropumps. He joined Nanyang Technological University in Singapore in 1996 as a post-doctoral fellow and worked on microscale cooling for electronics. He is now a post-doctoral scholar at the Micromanufacturing Laboratory (μ ML) in the Pennsylvania State University. His current research interests include high aspect ratio microfabrication, microfluidic systems, and smart materials for microactuators and MEMS.

Cheng Sun received his master degree in condensed matter physics in 1996. He is now a PhD student in the industrial and manufacturing engineering department. His major research interest is microfabrication.